### Table 2. ATTRIBUTES

Characteristics		Value	
Internal Input Pulldown Resistor		N/A	
Internal Input Pullup Resistor		N/A	
ESD Protection Human Body Model Machine Model Charged Device Model		> 4 kV > 200 V > 2 kV	
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)		Pb Pkg	Pb-Free Pkg
	SOIC-8 DFN8	Level 1 Level 1	Level 1 Level 1
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0	@ 0.125 in
Transistor Count		125 Devices	
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test			

1. For additional information, see Application Note AND8003/D.

### Table 3. MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V <sub>CC</sub>	Power Supply Voltage, Pin 2	-0.5 to 6.0	Vdc
T <sub>A</sub>	Operating Temperature Range	-40 to 85	°C
T <sub>stg</sub>	Storage Temperature Range	–65 to 150	°C
I <sub>O</sub>	Maximum Output Current, Pin 4		mA
$\theta_{\text{JC}}$	Thermal Resistance (Junction-to-Case) (Note 2) DFN8	35 to 40	°C/W

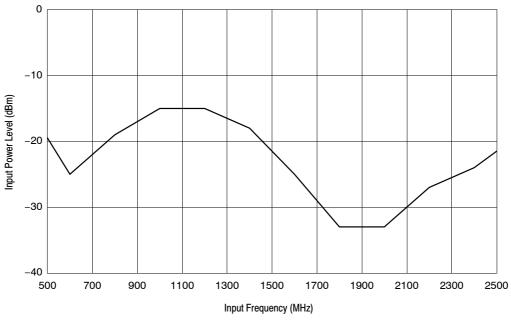
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

NOTE: ESD data available upon request.

2. JEDEC standard multilayer board – 2S2P (2 signal, 2 power). For DFN8 only, thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open.

## Table 4. ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 2.7 to 5.5 V; $T_A$ = -40 to 85°C, unless otherwise noted.)

Symbol	Characteristic		Min	Тур	Max	Unit
f <sub>t</sub>	Toggle Frequency (Sine Wave)		500	3.0	2.5	GHz
I <sub>CC</sub>	Supply Current		-	8.7	14	mA
I <sub>SB</sub>	Stand-By Current		-	100	200	μA
V <sub>IH1</sub>	Stand-By Input HIGH (SB)		2.0	-	V <sub>CC</sub> + 0.5 V	V
V <sub>IL1</sub>	Stand-By Input LOW (SB)		GND	-	0.8	V
V <sub>IH2</sub>	Divide Ratio Control Input HIGH (SW)		V <sub>CC</sub> – 0.4	V <sub>CC</sub>	V <sub>CC</sub> + 0.5 V	V
V <sub>IL2</sub>	Divide Ratio Control Input LOW (SW)		OPEN	OPEN	OPEN	
V <sub>OUT</sub>	Output Voltage Swing (2pF Load)	500–1000 MHz Input 1000–1500 MHz Input 1500–2500 MHz Input	800 400 200	- 450 250	- - -	mVpp
V <sub>IN</sub>	Input Voltage Sensitivity		200	-	1000	mVpp



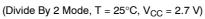


Figure 2. Typical Minimum Input Sensitivity versus Input Frequency

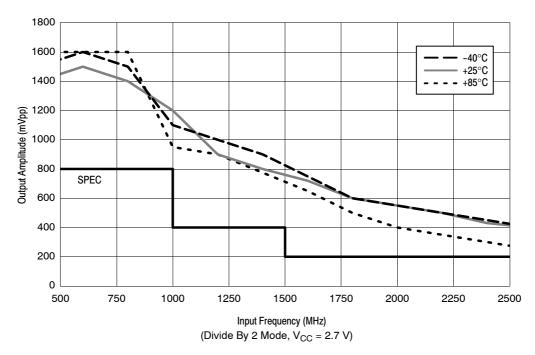


Figure 3. Typical Output Amplitude versus Frequency Over Temperature

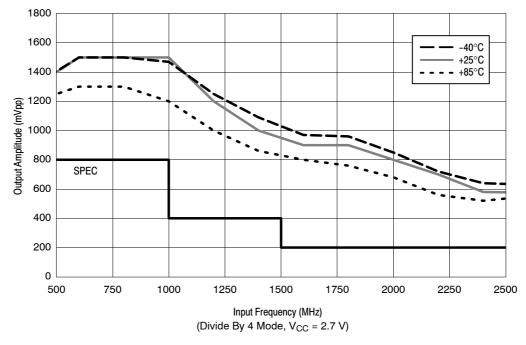


Figure 4. Typical Output Amplitude versus Frequency Over Temperature

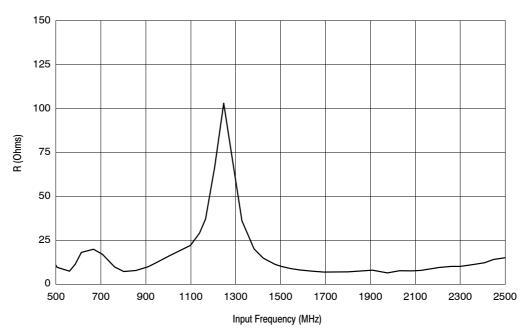


Figure 5. Input Impedance versus Frequency

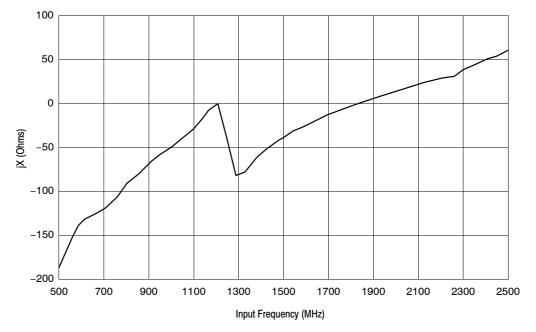


Figure 6. Input Impedance versus Frequency

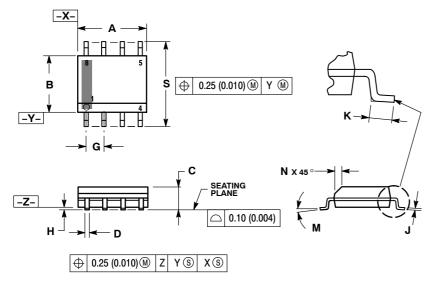
# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
MC12095D	SOIC-8	98 Units / Rail	
MC12095DG	SOIC-8 (Pb-Free)	98 Units / Rail	
MC12095DR2	SOIC-8	98 Units / Rail	
MC12095DR2G	SOIC-8 (Pb-Free)	98 Units / Rail	
MC12095MNR4	DFN8	1000 / Tape & Reel	
MC12095MNR4G	DFN8 (Pb–Free)	1000 / Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### PACKAGE DIMENSIONS

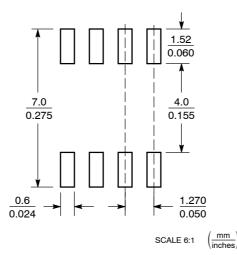
SOIC-8 NB CASE 751-07 **ISSUE AG** 

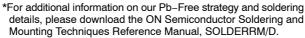


- NOTES:
  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
  751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.
  - STANDARD IS 751-07.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27	7 BSC	0.05	0 BSC
н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
К	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
Ν	0.25	0.50	0.010	0.020
s	5.80	6.20	0.228	0.244

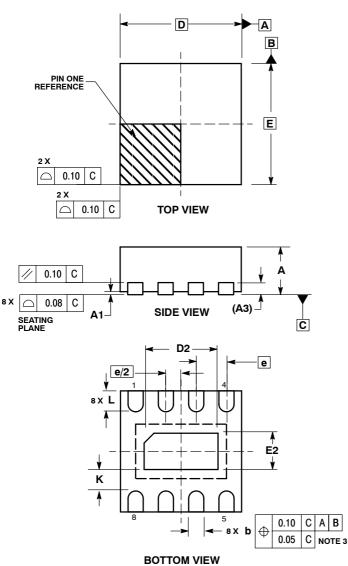
SOLDERING FOOTPRINT\*





#### PACKAGE DIMENSIONS

DFN8 CASE 506AA-01 **ISSUE C** 



NOTES

- 1. DIMENSIONING AND TOLERANCING PER
  - ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 2. З.
  - 0.25 AND 0.30 MM FROM TERMINAL. COPLANARITY APPLIES TO THE EXPOSED 4
  - PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.80	1.00	
A1	0.00	0.05	
A3	0.20	REF	
b	0.20	0.30	
D	2.00 BSC		
D2	1.10	1.30	
E	2.00 BSC		
E2	0.70	0.90	
е	0.50 BSC		
к	0.20		
L	0.25	0.35	

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